## Advanced Semiconductor Engineering, Inc.



# FOR IMMEDIATE RELEASE

#### Contact:

ASE, Inc. Joseph Tung, Chief Financial Officer Eddie Chang, Senior Director Joseph Su, Senior Manager Tel: +886-2-6636-5678 Fax: +886-2-2757-6121 ir@aseglobal.com http://www.aseglobal.com

### ADVANCED SEMICONDUCTOR ENGINEERING, INC. ANNOUNCES MONTHLY NET REVENUES

TAIPEI, TAIWAN, R.O.C., JULY 8, 2014 – ADVANCED SEMICONDUCTOR ENGINEERING, INC. (NYSE: ASX, TAIEX: 2311, "ASE" or the "Company"), announces its unaudited consolidated net revenues for June and 2<sup>nd</sup> quarter of 2014.

#### CONSOLIDATED NET REVENUES (UNAUDITED)

	Jun	May	Jun	Sequential	YoY
(NT\$ Million)	2014	2014	2013	Change	Change
Net Revenues	19,487	20,111	16,605	-3.1%	+17.4%
	Jun	May	Jun	Sequential	YoY
(US\$ Million)	2014	2014	2013	Change	<u>Change</u>
Net Revenues	650	668	557	-2.7%	+16.6%
	Q2	Q1	Q2	Sequential	YoY
				•	
(NT\$ Million)	2014	2014	2013	Change	Change
Net Revenues	58,615	54,700	50,760	+7.2%	+15.5%
	02	01	02	Coguantial	VeV
	Q2	Q1	Q2	Sequential	YoY
(US\$ Million)	2014	2014	2013	Change	<u>Change</u>
Net Revenues	1,945	1,814	1,706	+7.2%	+14.0%

Starting from Feb. 1, 2010, Universal Scientific Industrial Co., Ltd.'s consolidated revenues were consolidated into ASE Inc.'s consolidated revenues. Net revenues for the ATM assembly test and material business (excluding USI) are as follows:

	Jun	May	Jun	Sequential	YoY
(NT\$ Million)	2014	2014	2013	Change	<u>Change</u>
Net Revenues	13,124	13,435	12,204	-2.3%	+7.5%
	Jun	May	Jun	Sequential	YoY
(US\$ Million)	2014	2014	2013	Change	Change
Net Revenues	438	446	409	-1.9%	+6.9%

### ATM NET REVENUES (UNAUDITED)

### Advanced Semiconductor Engineering, Inc.



(NT\$ Million)	Q2 2014	Q1 2014	Q2 2013	Sequential Change	YoY Change
Net Revenues	39,266	34,351	36,295	+14.3%	+8.2%
	Q2	Q1	Q2	Sequential	YoY
(US\$ Million)	2014	2014	2013	Change	Change
Net Revenues	1,303	1,139	1,220	+14.4%	+6.8%

#### Safe Harbor Notice:

Safe Harbor Notice: This press release contains "forward-looking statements" within the meaning of Section 27A of the United States Securities Act of 1933, as amended, and Section 21E of the United States Securities Exchange Act of 1934, as amended, including statements regarding our future results of operations and business prospects. Although these forward-looking statements, which may include statements regarding our future results of operations, financial condition or business prospects, are based on our own information and information from other sources we believe to be reliable, you should not place undue reliance on these forward-looking statements, which apply only as of the date of this press release. The words "anticipate," "believe," "estimate," "expect," "intend," "plan" and similar expressions, as they relate to us, are intended to identify these forward-looking statements in this press release. Our actual results of operations, financial condition or business prospects may differ materially from those expressed or implied in these forward-looking statements for a variety of reasons, including risks associated with cyclicality and market conditions in the semiconductor or electronic industry; changes in our regulatory environment, including our ability to comply with new or stricter environmental regulations and to resolve environmental liabilities; demand for the outsourced semiconductor packaging, testing and electronic manufacturing services we offer and for such outsourced services generally; the highly competitive semiconductor or plane and the semiconductor or plane and to resolve environmental liabilities; demand for the outsourced semiconductor packaging, testing and electronic manufacturing services we offer and for such outsourced services generally; the highly competitive semiconductor or back and the semiconductor or selectonic the semiconductor or semiconductor or semiconductor or semiconductor or semiconductor or semiconductor or semiconductor packaging, testing and electonic manufact electronic manufacturing services we offer and for such outsourced services generally; the highly competitive semiconductor or manufacturing industry we are involved in; our ability to introduce new technologies in order to remain competitive; international business activities; our business strategy; our future expansion plans and capital expenditures; the strained relationship between the Republic of China and the People's Republic of China; general economic and political conditions; the recent global economic crisis; possible disruptions in commercial activities caused by natural or human-induced disasters; fluctuations in foreign currency exchange rates; and other factors. For a discussion of these risks and other factors, please see the documents we file from time to time with the Scentritice and Eucharge Commission of these risks and other factors. For a discussion of these risks and other factors. For a discussion of these risks and other factors. For a discussion of these risks and other factors. For a discussion of these risks and other factors. For a discussion of these risks and other factors. For a discussion of these risks and other factors. For a discussion of these risks and other factors. For a discussion of these risks and other factors. For a discussion of these risks and other factors. For a discussion of these risks and other factors. time with the Securities and Exchange Commission, including our 2013 Annual Report on Form 20-F filed on April 17, 2014.